

Inrush with 360uF

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Linear Technology

360 μ F

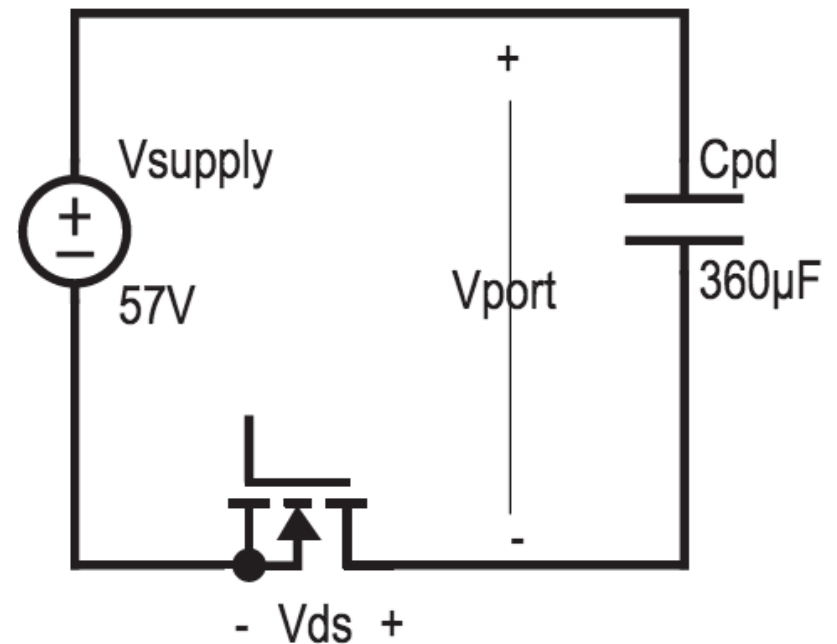
- New .bt text:
 - Input inrush current at startup is limited by the PSE if CPort per pair-set < 180 μ F, as specified in Table 33–11.
- 180 μ F/pairset = 360 μ F total

PSE Gets Hotter

- T_{pon} doesn't change, so MOSFET inrush power increases by 2x over AT inrush
- SOA is a function of P^2T , so MOSFET peak SOA requirements increase by 4x
- Peak power occurs at the start of inrush and reduces as inrush proceeds
 - This is why foldback works

Foldback

- In current-limited inrush, peak MOSFET power happens with maximum V_{ds} (minimum port voltage)
 - $P = I_{port} * V_{ds} = I_{port} * (V_{supply} - V_{port})$
- Foldback reduces the current with large V_{ds} and then increases it as V_{ds} shrinks (V_{port} increases)
- **Foldback is currently out-of-scope for I_{lim} but forbidden during I_{inrush} (by I_{inrush_2p} (min))**



Example Inrush Foldback Curve

- Ilim curve from LTC4266 Datasheet
- This would cover total PSE port current, or pair current with Y-axis scaled /2
- **This provides a 4x P²T improvement for all PSEs: 1ch, 2ch, internal, external**

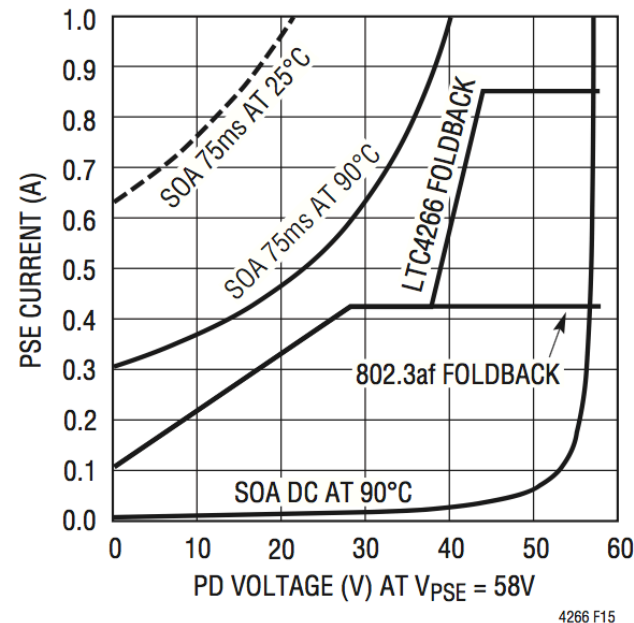


Figure 15. LTC4266 Foldback vs FET Safe Operating Area at 90°C Ambient

Solutions

- Lower I_{inrush_2P} (min) for Type 3/4 to $\sim 200\text{mA}$ (from 400mA now) with a note that says PSE must charge $< 360\mu\text{F}$ to V_{port_PSE} by T_{inrush_max}
- Change PD spec back to $180\mu\text{F}$ total
- Buy a bigger MOSFET

Straw Poll (Pick One Only)

- I prefer:
 - Lowering `linrush_2P` (min) for Types 3/4 and requiring 360uF to be charged within `Tinrush` (max)
 - Change PD to 180μF max
 - No changes to the text